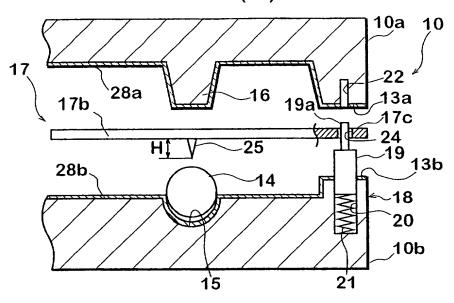
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FIG. 1 (A)



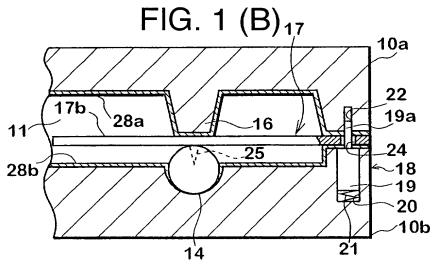
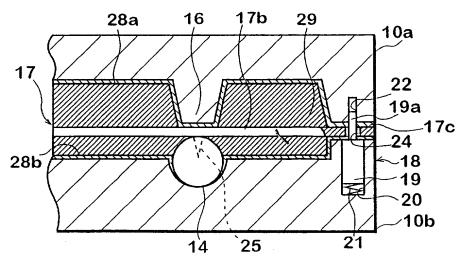
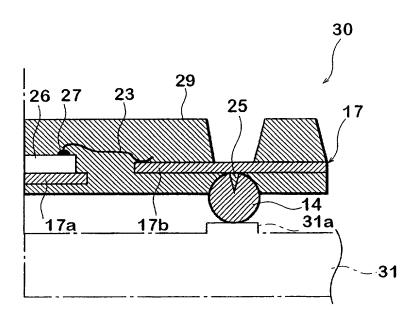


FIG. 1 (C)



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RABIN & BERDO, P.C.
Customer NO.: 23995
Attv Docket: OKI 286

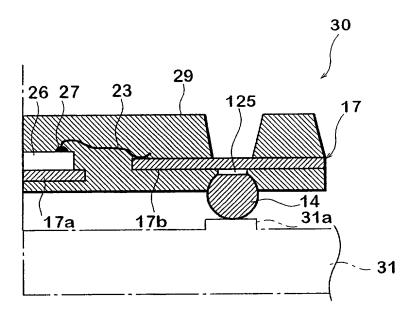
FIG. 2



PACKAGE (1)

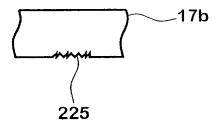
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FIG. 4



PACKAGE (2)

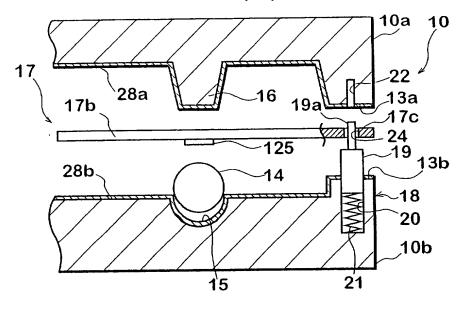
FIG. 5



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FIG. 3(A)



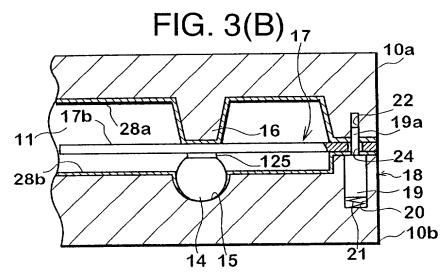
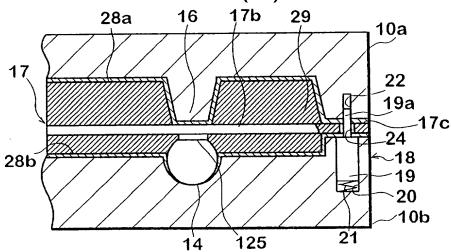


FIG. 3(C)



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FIG. 6(A)

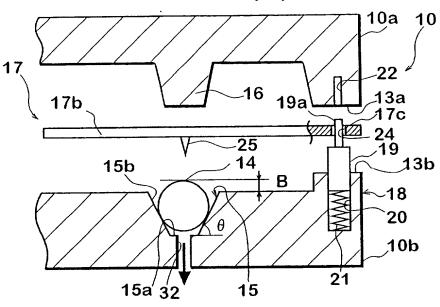


FIG. 6(B) 10a 22 19a 17b. 16 15b 11 /13b 19 -18 20 17 10b 21 15a 32 15

FIG. 6(C) 17b 29 25 10a 10 22 / /13b -18 20 17 θ 10b 21 15a 32 15b

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Atty Docket: OKI 286

FIG. 7(A)

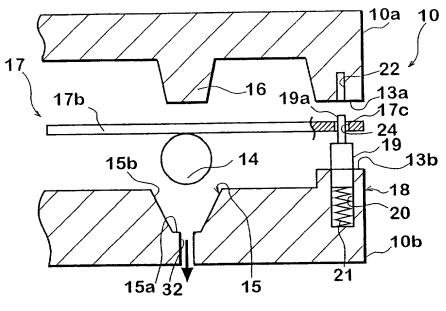


FIG. 7(B)

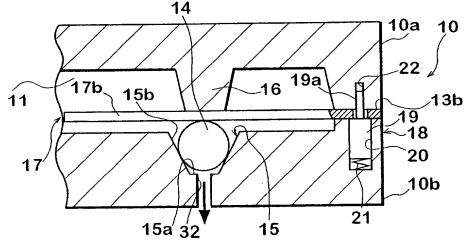


FIG. 7(C)

